



REV.	DESCRIPTION	DRAWN	CHECKED	APPROVED
A	NEW RELEASE	JLZ 10/08/14'		

Notes

1. Material:
 - 1.1. Housing: High Thermoplastic LCP UL 94v-0 Color Of Black.
 - 1.2. Contacts: Copper Alloy.
 - 1.3. Shell: Stainless Steel
2. Finish:
 - 2.1. Contact Area: Gold Over Nickel.
 - 2.2. Solder Area: Matte Tin.
3. Specifications:
 - 3.1. Operation Temperature: -40° C TO +105° C.
 - 3.2. Insulation Resistance: 1000MΩ Min.
 - 3.3. Contact Resistance: 50mΩ max.
 - 3.4. Withstanding Voltage: 500V AC 1 Min.
 - 3.5. Voltage Rating: 30V AC/DC.
 - 3.6. Current Rating: 1.0 mA.
4. Product Numbrt Code:

DS1138-03 - XX X X X X X X X

- Packing Type
R: Tape On Reel
- Shell plating
S: Stainless
- Housing color
B: Black
- Contact Plating
4: Selective 3u" gold
- Mounting type
S: SMT type
- Connector type
S: Socket
- No. of contacts
08:8pin

GENERAL TOLERANCE	ANGLE TOLERANCE
X. ±0.60	X. ±5°
.X ±0.38	.X ±3°
.XX ±0.25	.XX ±2°

PROJECTION	TITLE
	1.27mm SIM Card H=3.1mm 8P Dual SMT Type
UNITS	mm
SHEET SIZE	A4
SERIES	DS1138-03 SERIES

DRAWING TYPE	CUSTOMER
SCALE	1:1 SHEET 1 OF 1
DRAWING NO.	C-DS1138-03-XXXXXXX

晨翔电子有限公司
CONNFLY® CONNFLY ELECTRONIC CO., LTD

RECOMMENDED P.C.B LAYOUT
GENERAL TOLERANCES: ±0.05